

1.0X0.5mm SMD CHIP LED LAMP

Part Number: APHHS1005SYCK

Super Bright Yellow

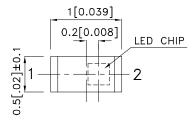
Features

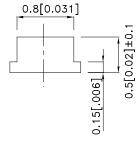
- ●1.0mmX0.5mm SMT LED, 0.5mm thickness.
- •Low power consumption.
- Wide viewing angle.
- •Ideal for backlight and indicator.
- •Various colors and lens types available.
- ●Package: 2000pcs / reel .
- •Moisture sensitivity level : level 3.
- ●RoHS compliant.

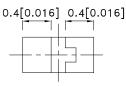
Description

The Super Bright Yellow device is made with AlGaInP (on GaAs substrate) light emitting diode chip.

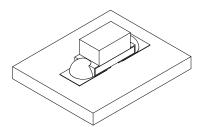
Package Dimensions











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- Specifications are subject to change without notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.





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Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] Dice Lens Type @ 20mA			Viewing Angle [1]
			Min.	Тур.	201/2	
APHHS1005SYCK	Super Bright Yellow (AlGaInP)	WATER CLEAR	50	150	120°	

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Yellow	590		nm	IF=20mA
λD [1]	Dominant Wavelength	Super Bright Yellow	590		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Yellow	20		nm	IF=20mA
С	Capacitance	Super Bright Yellow	20		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Super Bright Yellow	2	2.5	V	I=20mA
lr	Reverse Current	Super Bright Yellow		10	uA	V _R =5V

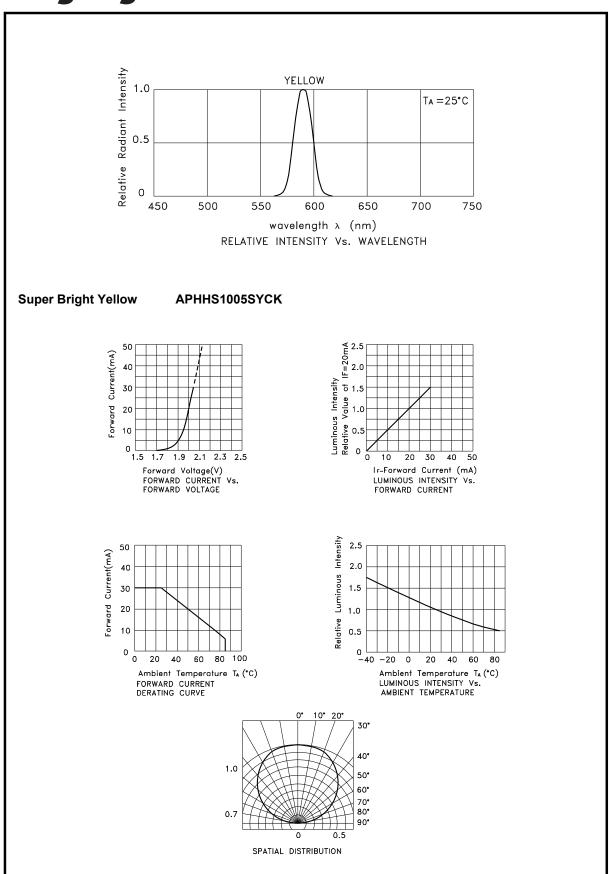
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Parameter	Super Bright Yellow	Units	
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	175	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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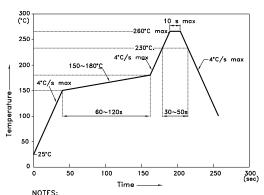
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



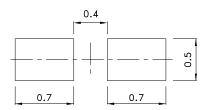
NOTES:

1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

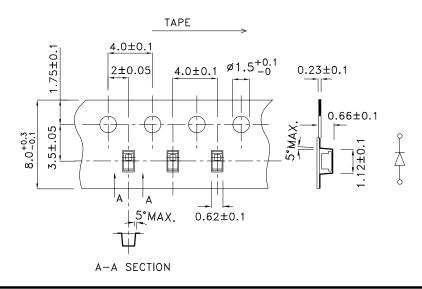
2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3.Number of reflow process shall be 2 times or less.

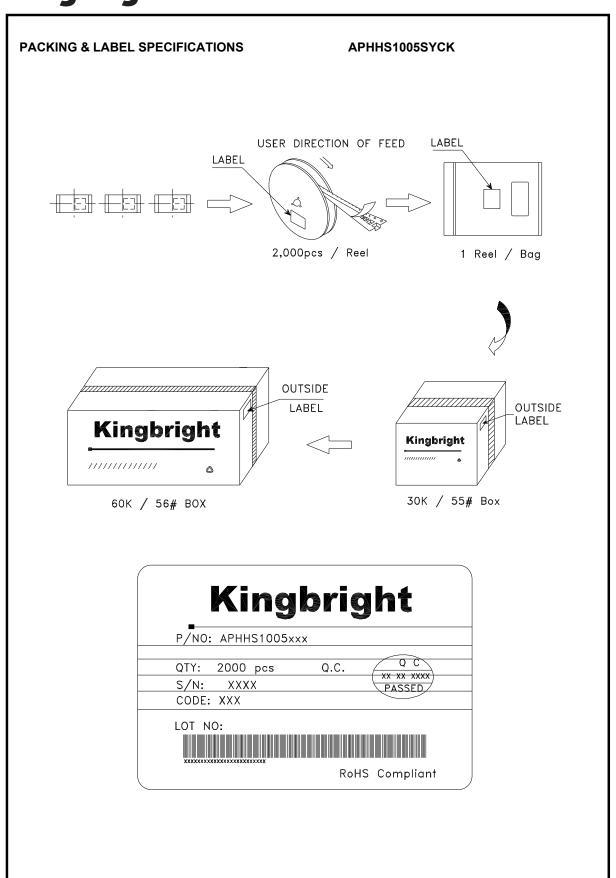
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units : mm)



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